

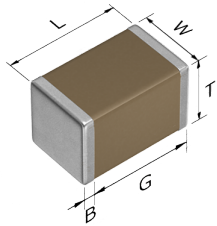


TDK item description CGA4J2X8R1H473KT5***

Applications	 Automotive Grade
Feature	<div><div>AEC-Q200</div>AEC-Q200</div> <div><div>150°C</div>High Temperature Application</div> <div><div>Open</div>Open Mode</div>
Series	CGA4(2012) [EIA 0805]
Status	 Production (Not Recommended for New Design)
Brand	TDK

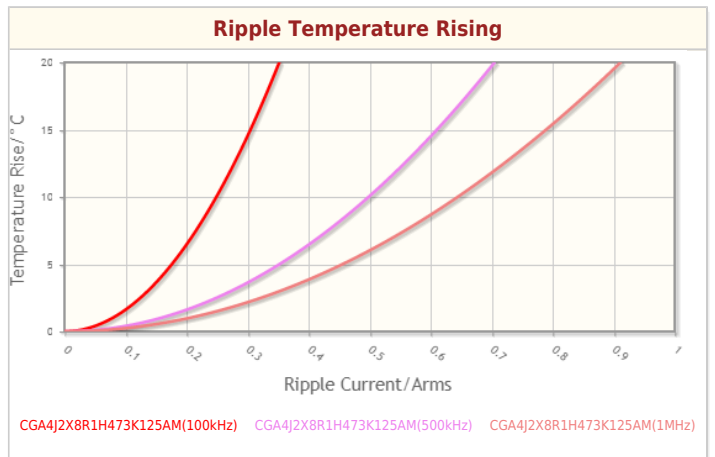
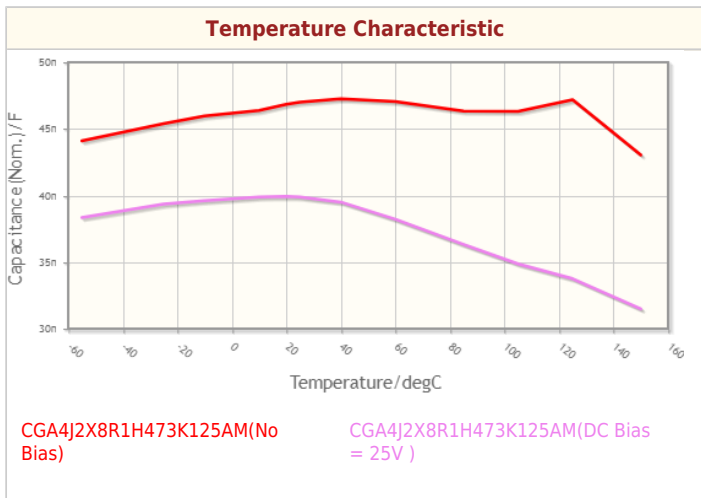
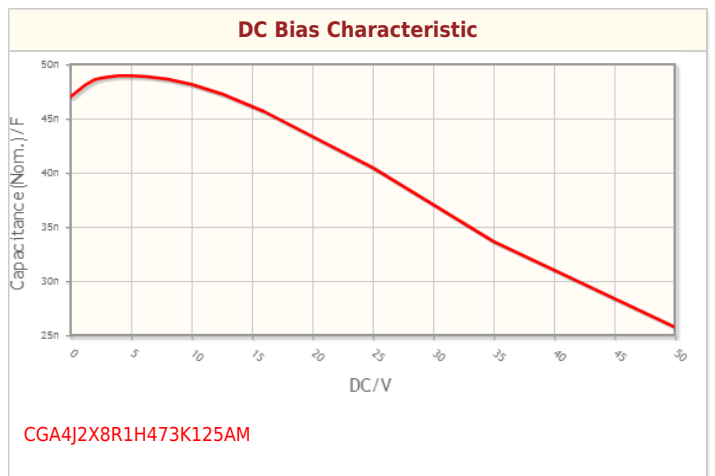
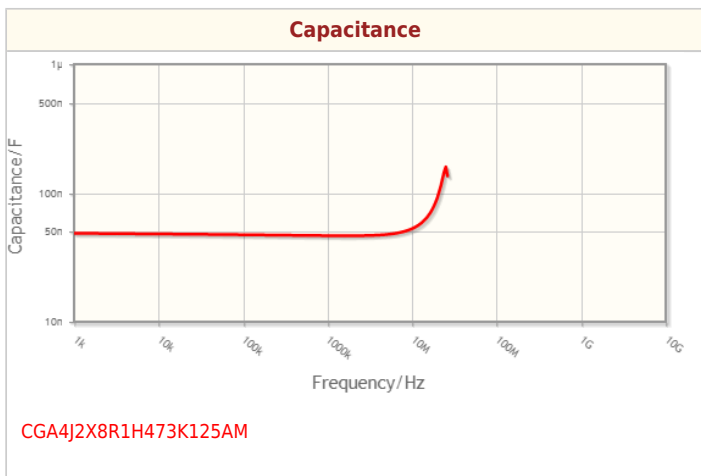
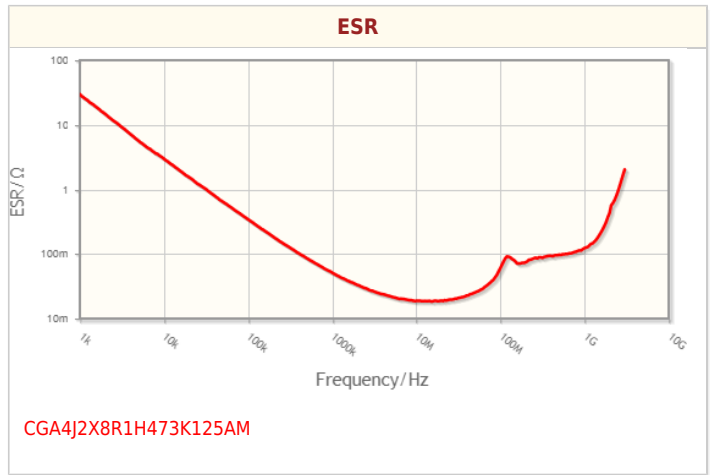
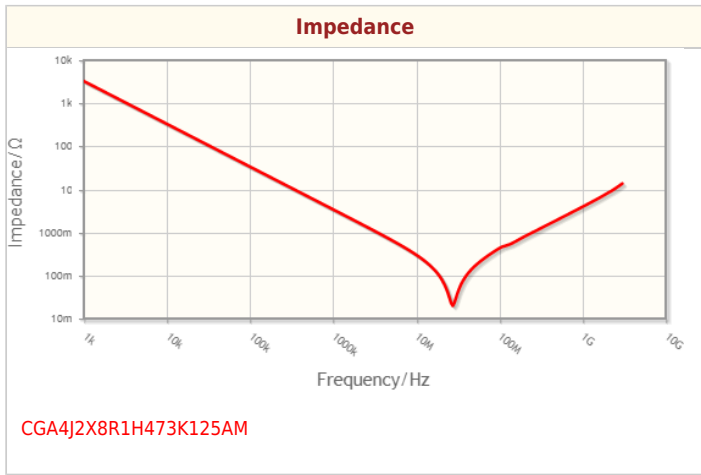


Size	
Length(L)	2.00mm ±0.20mm
Width(W)	1.25mm ±0.20mm
Thickness(T)	1.25mm ±0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	0.50mm Min.
Recommended Land Pattern (PA)	1.00mm to 1.30mm(Flow Soldering) 0.90mm to 1.20mm(Reflow Soldering)
Recommended Land Pattern (PB)	1.00mm to 1.20mm(Flow Soldering) 0.70mm to 0.90mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.80mm to 1.10mm(Flow Soldering) 0.90mm to 1.20mm(Reflow Soldering)

Electrical Characteristics	
Capacitance	47nF ±10%
Rated Voltage	50VDC
Temperature Characteristic	X8R(±15%)
Dissipation Factor (Max.)	3%
Insulation Resistance (Min.)	10000MΩ

Other	
Soldering Method	Wave (Flow) Reflow
AEC-Q200	YES
Packing	Embossed (Plastic)Taping [180mm Reel]
Package Quantity	2000pcs

Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)



Associated Images

